

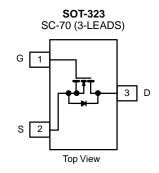
COMPLIANT HALOGEN

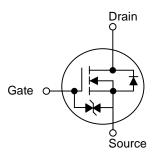
FREE

2N7002KDW-VB Datasheet

N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V_{DS} (V) $R_{DS(on)}$ (Ω) I_{D} (I_{D}					
60	2 at V _{GS} = 10 V	300			





FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Low On-Resistance: 2 Ω
- Low Threshold: 2 V (typ.)
- Low Input Capacitance: 25 pF
- Fast Switching Speed: 25 ns
- Low Input and Output Leakage
- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

BENEFITS

- Low Offset Voltage
- Low-Voltage Operation
- Easily Driven Without Buffer
- **High-Speed Circuits**
- Low Error Voltage

APPLICATIONS

- Direct Logic-Level Interface: TTL/CMOS
- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- **Battery Operated Systems**
- Solid-State Relays

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V_{DS}	60	V	
Gate-Source Voltage	V _{GS}	± 20	V		
Continuous Drain Current (T _{.I} = 150 °C) ^b	T _A = 25 °C	- I _D	300	mA	
Continuous Drain Current (1) = 150 °C)	T _A = 100 °C		190		
Pulsed Drain Current ^a		I _{DM}	800		
Davis Discinstianh	T _A = 25 °C	P _D	0.35	W	
Power Dissipation ^b	T _A = 100 °C		0.14		
Maximum Junction-to-Ambient ^b	R _{thJA}	350	°C/W		
Operating Junction and Storage Temperature Range		$T_{J_{i}}T_{stg}$	- 55 to 150	°C	

Notes:

- a. Pulse width limited by maximum junction temperature.
- b. Surface Mounted on FR4 board.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.



			Limits				
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 10 \mu\text{A}$	60			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1		2.5		
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 10	μΑ	
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 15 \text{ V}$			1		
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}$			± 150	nA	
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			± 1000		
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$			± 100		
Zana Oata Valta na Busia Ourmant		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			500		
	I _{D(on)}	$V_{GS} = 10 \text{ V}, V_{DS} = 7.5 \text{ V}$	800			^	
On-State Drain Current ^a		$V_{GS} = 4.5 \text{ V}, V_{DS} = 10 \text{ V}$	500			mA	
	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA}$		2			
Drain-Source On-Resistance ^a		$V_{GS} = 4.5 \text{ V}, I_D = 200 \text{ mA}$	$V_{GS} = 4.5 \text{ V}, I_D = 200 \text{ mA}$ 4			Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 200 mA	100			mS	
Diode Forward Voltage	V _{SD}	$I_S = 200 \text{ mA}, V_{GS} = 0 \text{ V}$			1.3	V	
Dynamic ^a			1	1		•	
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}$ $I_{D} \cong 250 \text{ mA}$		0.4	0.6	nC	
Input Capacitance	C _{iss}			30			
Output Capacitance	C _{oss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}$		6		pF	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		2.5			
Switching ^{a, b, c}							
Turn-On Time	t _{d(on)}	$V_{DD} = 30 \text{ V}, R_{L} = 150 \Omega$			25	ns	
Turn-Off Time	t _{d(off)}	$I_D \cong 200 \text{ mA}, V_{GEN} = 10 \text{ V}, R_G = 10 \Omega$			35		

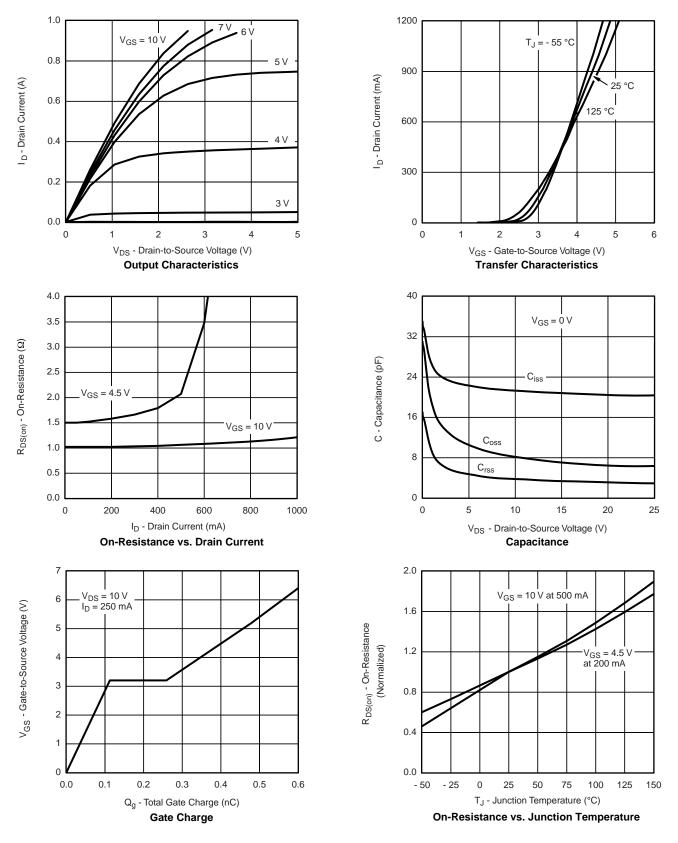
Notes:

- a. For DESIGN AID ONLY, not subject to production testing. b. Pulse test: PW \leq 300 μ s duty cycle \leq 2 %.
- c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

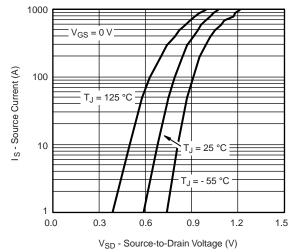


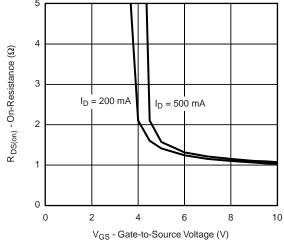
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





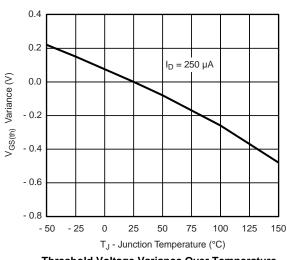
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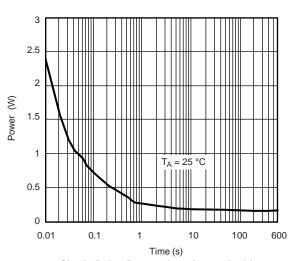




Source-Drain Diode Forward Voltage

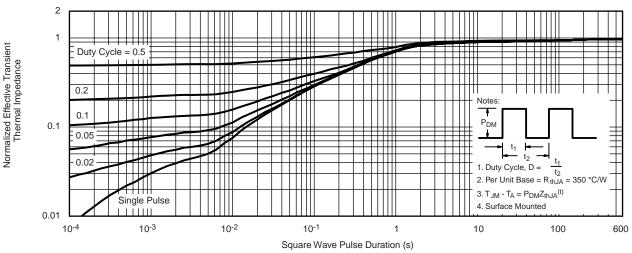






Threshold Voltage Variance Over Temperature

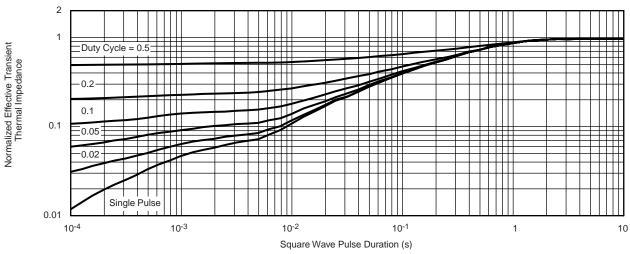
Single Pulse Power, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



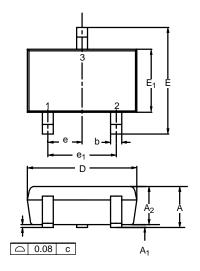
Normalized Thermal Transient Impedance, Junction-to-Foot

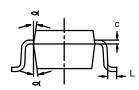
Note

- · The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



SC-70: 3-LEADS





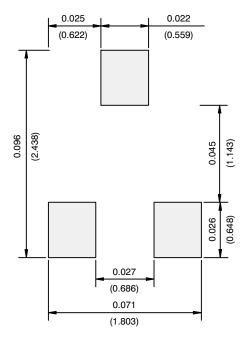
	MILLIMETERS			INCHES		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.90	-	1.10	0.035	_	0.043
A_1	_	-	0.10	-	_	0.004
A ₂	0.80	-	1.00	0.031	_	0.039
b	0.25	-	0.40	0.010	_	0.016
С	0.10	-	0.25	0.004	_	0.010
D	1.80	2.00	2.20	0.071	0.079	0.087
Ε	1.80	2.10	2.40	0.071	0.083	0.094
E ₁	1.15	1.25	1.35	0.045	0.049	0.053
е	0.65BSC			0.026BSC		
e ₁	1.20	1.30	1.40	0.047	0.051	0.055
L	0.10	0.20	0.30	0.004	0.008	0.012
Þ	7°Nom			7°Nom		
ECN: S-03946—Rev. C, 09-Jul-01						

DWG: 5549



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RECOMMENDED MINIMUM PADS FOR SC-70: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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